

### Octal channel high-side driver



### Features

- CMOS compatible input
- Junction overtemperature protection
- Case overtemperature protection for thermal independence of the channels
- Current limitation
- Shorted load protection
- Undervoltage shutdown
- Protection against loss of ground
- Very low standby current
- Compliance to 61000-4-4 IEC test up to 4 kV

### Description

The VN808CM-E and VN808CM-32-E are monolithic devices designed with STMicroelectronics VIPower M0-3 technology, intended to drive any kind of load with one side connected to ground. It can be driven by using a 3.3 V logic supply.

Active current limitation combined with thermal shutdown and automatic restart protect the device against overload. In overload conditions, the channel turns OFF and ON again automatically to maintain the junction temperature between  $T_{JSD}$  and  $T_R$ . If this condition causes the case temperature to trigger  $T_{CSD}$ , then overloaded channels are turned OFF and can be turned back ON only when the case temperature decreases down to  $T_{CR}$ .

. Non-overloaded channels continue to operate normally. The device automatically turns OFF in case of ground pin disconnection. This device is especially suitable for industrial applications conforming to IEC 61131.

Product status link	
<a href="#">VN808CM-E</a>	
<a href="#">VN808CM-32-E</a>	

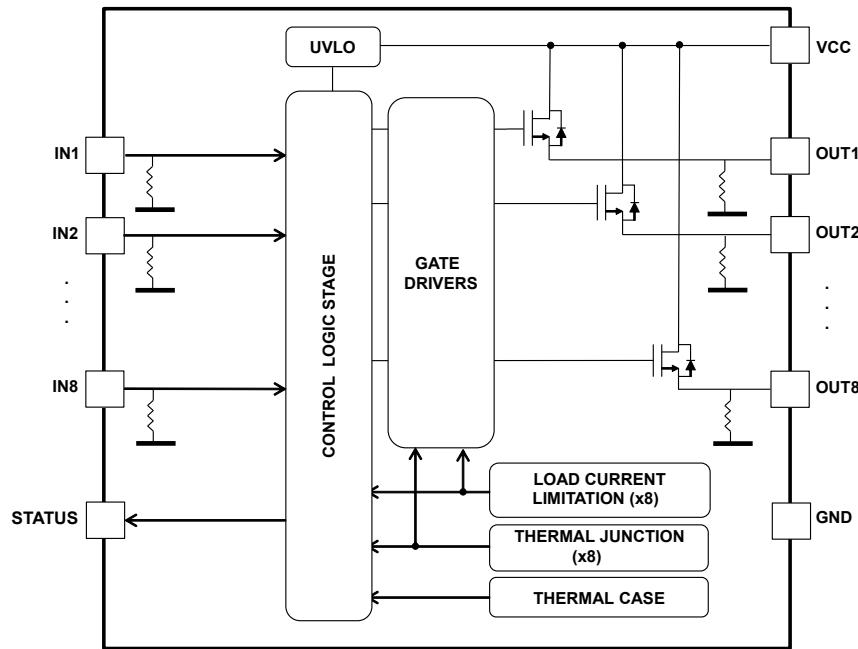


Type	$R_{DS(on)}^{(1)}$	$I_{OUT}$	$V_{CC}$
VN808CM-E	160 mΩ	0.7 A	45 V
VN808CM-32-E	160 mΩ	1 A	45 V

1. Per channel

## 1 Overview

Figure 1. Internal schematic



## 2

## Maximum ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Max.	Unit
V <sub>CC</sub>	DC Supply Voltage	45	V
-I <sub>GND</sub>	DC Ground Reverse Current	250	mA
	TRAN ground reverse current (pulse duration < 1 ms)	6	A
I <sub>OUT</sub>	DC Output Current	Internally limited	A
-I <sub>OUT</sub>	Reverse DC Output Current	2	A
I <sub>IN</sub>	DC Input Current	±10	mA
V <sub>IN</sub>	Input Voltage Range	5.5	V
V <sub>ESD</sub>	Electrostatic discharge (R = 1.5K Ω; C = 100pF)	2000	V
P <sub>TOT</sub>	Power dissipation at T <sub>c</sub> = 25°C	96	W
EAS	Single pulse Avalanche Energy per channel, all channels driven simultaneously (T <sub>AMB</sub> = 125 °C, I <sub>OUT</sub> = 0.6 A per channel)	1.15	J
T <sub>J</sub>	Junction Operating Temperature	Internally limited	°C
T <sub>c</sub>	Case Operating Temperature	Internally limited	°C
T <sub>STG</sub>	Storage Temperature	-40 to 150	°C

Table 2. Thermal data

Symbol	Parameter	Max. value	Unit
R <sub>th(JC)</sub>	Thermal resistance junction-case	1.3	°C/W
R <sub>th(JA)</sub>	Thermal resistance junction-ambient	50	°C/W

1. When mounted on FR4 printed circuit board with 0.5 cm<sup>2</sup> of copper area (at least 35 µm thick) connected to all TAB pins.

### 3 Electrical characteristics

$10.5 \text{ V} < V_{CC} < 32 \text{ V}$ ;  $-40^\circ\text{C} < T_J < 125^\circ\text{C}$ ; unless otherwise specified.

**Table 3. Power section**

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$V_{USD}$	$V_{CC}$ under-voltage turn-off threshold		7		10.5	V
$R_{ON}$	On-state resistance	$I_{OUT} = 0.5\text{A}; T_J = 25^\circ\text{C}$			160	$\text{m}\Omega$
		$I_{OUT} = 0.5\text{A}; T_J = 125^\circ\text{C}$			280	$\text{m}\Omega$
$I_S$	Supply current	OFF-state $V_{CC} = 24 \text{ V}; T_{CASE} = 25^\circ\text{C}$			150	$\mu\text{A}$
		ON-state (all channels ON) $V_{CC} = 24 \text{ V}; T_{CASE} = 100^\circ\text{C}$			12	mA
$I_{LGND}$	Output current at turn-off	$V_{CC} = V_{GND} = 24 \text{ V}; V_{STAT} = V_{IN} = 5 \text{ V}; V_{OUT} = 0 \text{ V}$			1	mA
$I_{L(OFF)}$	OFF-state output current	$V_{IN} = V_{OUT} = 0 \text{ V}$	0		5	$\mu\text{A}$
$V_{OUT(OFF)}$	OFF-state output voltage	$V_{IN} = 0 \text{ V}; I_{OUT} = 0 \text{ A}$			3	V
$t_d(VCCON)$	Power-on delay time from $V_{CC}$ rising edge	(see Figure 5)		1		ms

**Table 4. Switching ( $V_{CC} = 24 \text{ V}$ )**

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
$t_{ON}$	Turn-ON time	$R_L = 48 \Omega$ from 80% $V_{OUT}$ (see Figure 4)		50	100	$\mu\text{s}$
$t_{OFF}$	Turn-OFF time	$R_L = 48 \Omega$ to 10% $V_{OUT}$ (see Figure 4)		75	150	$\mu\text{s}$
$dV_{OUT}/dt_{(ON)}$	Turn-ON voltage slope	$R_L = 48 \Omega$ from $V_{OUT} = 2.4 \text{ V}$ to $V_{OUT} = 19.2 \text{ V}$ (see Figure 4)		0.7		$\text{V}/\mu\text{s}$
$dV_{OUT}/dt_{(OFF)}$	Turn-OFF voltage slope	$R_L = 48 \Omega$ from $V_{OUT} = 21.6 \text{ V}$ to $V_{OUT} = 2.4 \text{ V}$ (see Figure 4)		1.5		$\text{V}/\mu\text{s}$

**Table 5. Input pins**

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
$V_{INL}$	Input low level				1.25	V
$I_{INL}$	Low level input current	$V_{IN} = 1.25 \text{ V}$	1			$\mu\text{A}$
$V_{INH}$	Input high level		2.25			V
$I_{INH}$	High level input current	$V_{IN} = 2.25 \text{ V}$			10	$\mu\text{A}$
$V_{IN(HYST)}$	Input hysteresis voltage		0.25			V
$V_{ICL}$	Input clamp voltage	$I_{IN} = 1 \text{ mA}$	6.0	6.8	8.0	V
		$I_{IN} = -1 \text{ mA}$		-0.7		

**Table 6. Protections**

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
T <sub>CSD</sub>	Case shut-down temperature		125	130	135	°C
T <sub>CR</sub>	Case reset temperature		110			°C
T <sub>CHYST</sub>	Case thermal hysteresis		7	15		°C
T <sub>JSD</sub>	Junction shutdown temperature		150	175	200	°C
T <sub>R</sub>	Junction reset temperature		135			°C
T <sub>HYST</sub>	Junction thermal hysteresis		7	15		°C
I <sub>PEAK</sub>	Maximum DC output current before limitation	V <sub>CC</sub> = 24 V; R <sub>LOAD</sub> = 10 mΩ	1.1		2.6	A
I <sub>LIM</sub>	DC short-circuit current limitation per channel	V <sub>CC</sub> = 24 V; R <sub>LOAD</sub> = 10 mΩ	0.7 <sup>(1)</sup>		1.7	A
			1 <sup>(2)</sup>			
V <sub>DEMAG</sub>	Turn-OFF output clamp voltage	I <sub>OUT</sub> = 0.5A; L = 6 mH	V <sub>CC-57</sub>	V <sub>CC-52</sub>	V <sub>CC-47</sub>	V

1. VN808CM-E

2. VN808CM-32-E

**Table 7. Status pin**

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
I <sub>HSTAT</sub>	STATUS pin high level current	V <sub>CC</sub> = 18 to 32 V; R <sub>STAT</sub> = 1 kΩ (Fault condition)	2	3	4	mA
I <sub>LSTAT</sub>	STATUS pin leakage current	Normal operation; V <sub>CC</sub> = 32 V			0.1	µA
V <sub>CLSTAT</sub>	STATUS pin clamp voltage	I <sub>STAT</sub> = 1 mA	6.0	6.8	8.0	V
		I <sub>STAT</sub> = -1 mA		-0.7		

## 4

## Pin connections

Figure 2. Connection diagram (top view)

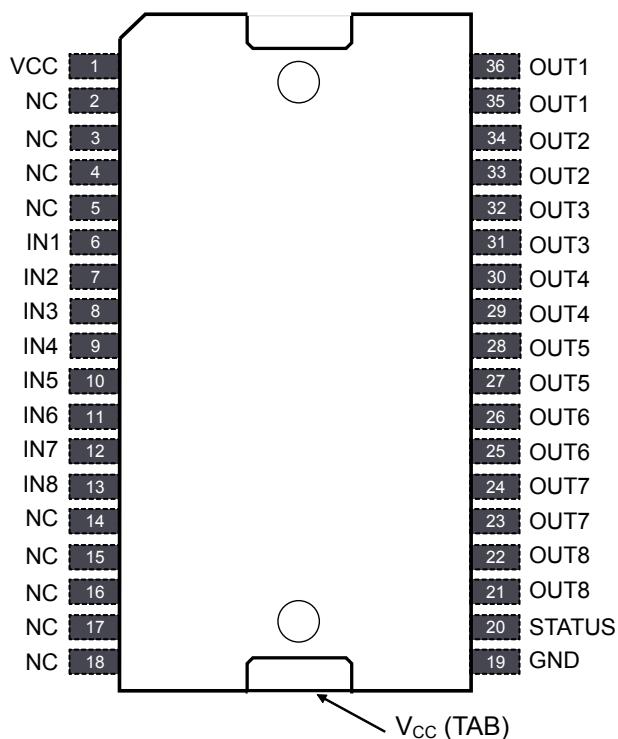


Table 8. Pin functions

Pin	Symbol	Description
1	V <sub>CC</sub>	Positive power supply voltage
2	N.C.	Not Connected
3	N.C.	Not Connected
4	N.C.	Not Connected
5	N.C.	Not Connected
6	IN1	Channel 1 input
7	IN2	Channel 2 input
8	IN3	Channel 3 input
9	IN4	Channel 4 input
10	IN5	Channel 5 input
11	IN6	Channel 6 input
12	IN7	Channel 7 input
13	IN8	Channel 8 input
14	N.C.	Not Connected
15	N.C.	Not Connected
16	N.C.	Not Connected
17	N.C.	Not Connected
18		
19		GND
20		STATUS
21		
22		OUT8
23		OUT7
24		OUT7
25		OUT6
26		OUT6
27		OUT5
28		OUT5
29		OUT4
30		OUT4
31		OUT3
32		OUT3
33		OUT2
34		OUT2
35		OUT1
36		OUT1

Pin	Symbol	Description
18	N.C.	Not Connected
19	GND	Output power ground
20	STATUS	Common open source diagnostic for over-temperature
21	OUT8	Channel 8 power output
22		
23	OUT7	Channel 7 power output
24		
25	OUT6	Channel 6 power output
26		
27	OUT5	Channel 5 power output
28		
29	OUT4	Channel 4 power output
30		
31	OUT3	Channel 3 power output
32		
33	OUT2	Channel 2 power output
34		
35	OUT1	Channel 1 power output
36		
TAB	Vcc	Exposed tab internally connected to V <sub>CC</sub> , positive power supply voltage

## 5 Current and voltage conventions and truth table

Figure 3. Current and voltage conventions

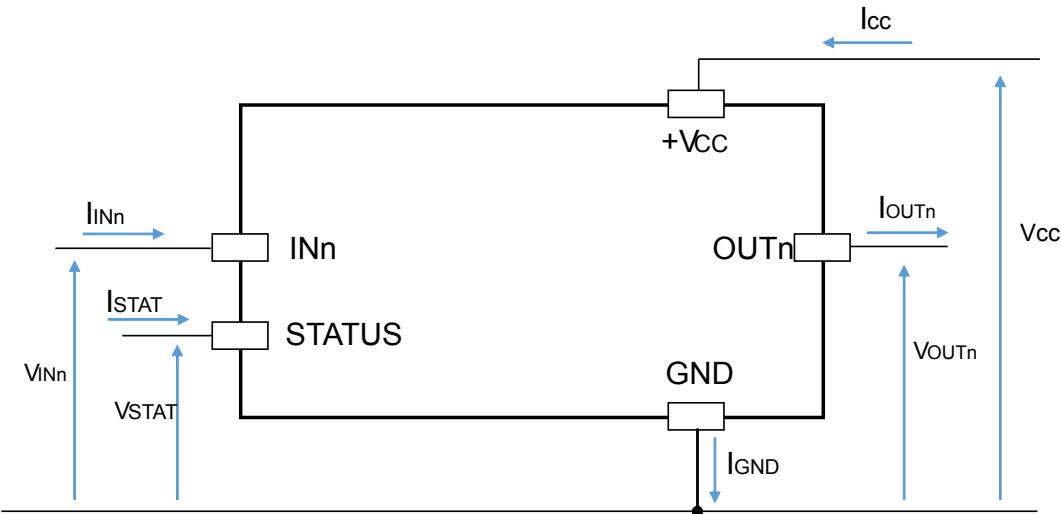


Table 9. Truth table

Conditions	INPUTn	OUTPUTn	STATUS
Normal operation	L	L	L
	H	H	L
Current limitation	L	L	L
	H	X	L
Over-temperature (see Figure 13 and Figure 14)	L	L	L
	H	L	H
Undervoltage	L	L	X
	H	L	X

## 6 Switching time waveforms

Figure 4. Turn-ON and turn-OFF

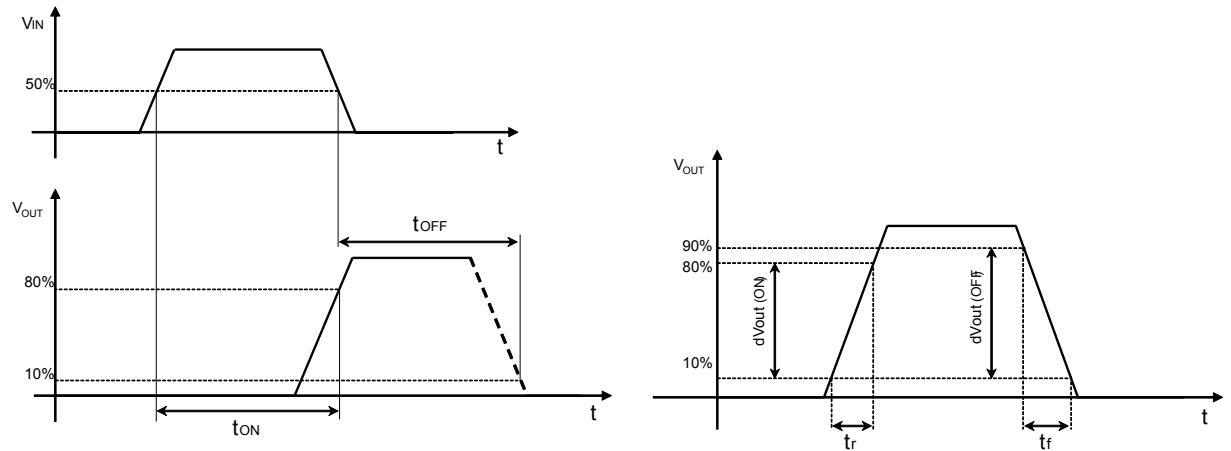
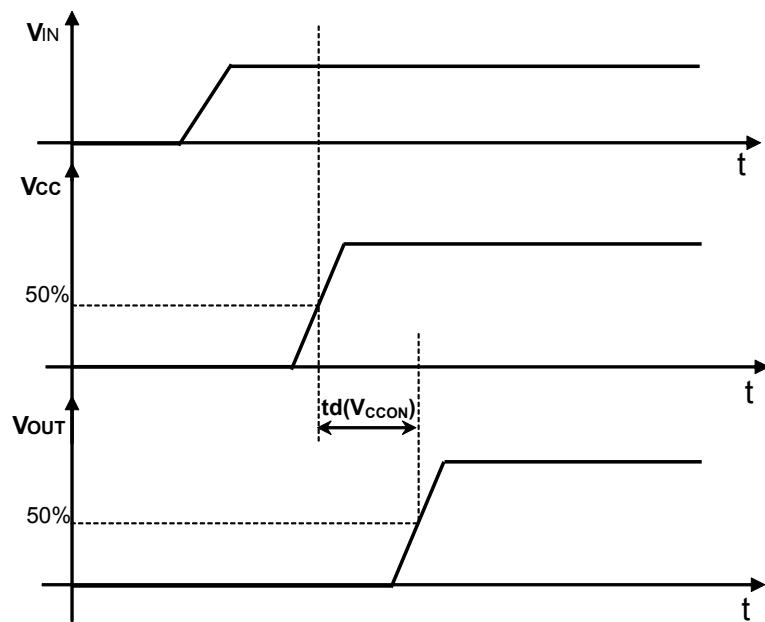


Figure 5.  $V_{CC}$  turn-ON



## 7

## Power section

## 7.1

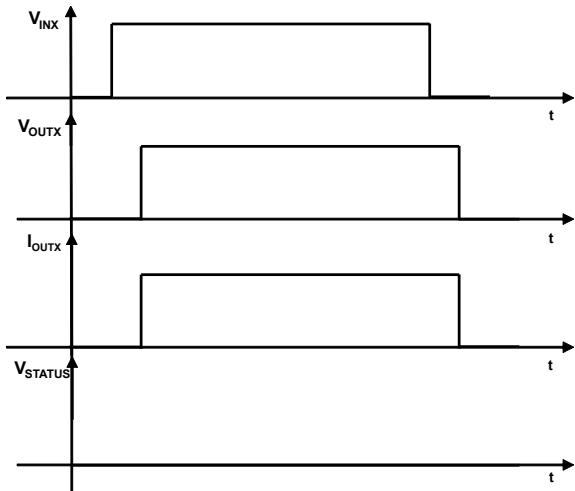
## Current limitation

The current limitation process is activated when the current sense connected on the output stage measures a current value higher than a fixed threshold.

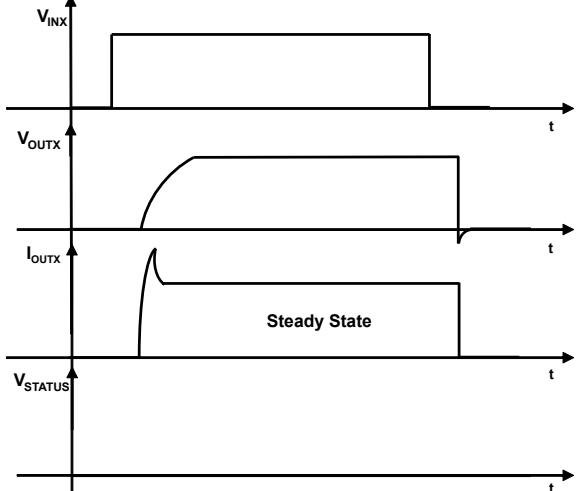
When this condition is verified, the gate voltage is modulated to prevent the output current from rising above the limitation value.

The following figures show typical output current waveforms with different load conditions.

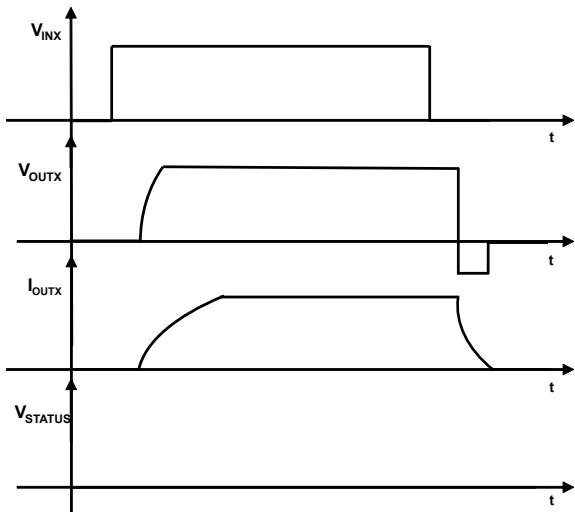
**Figure 6. Switching on resistive load**



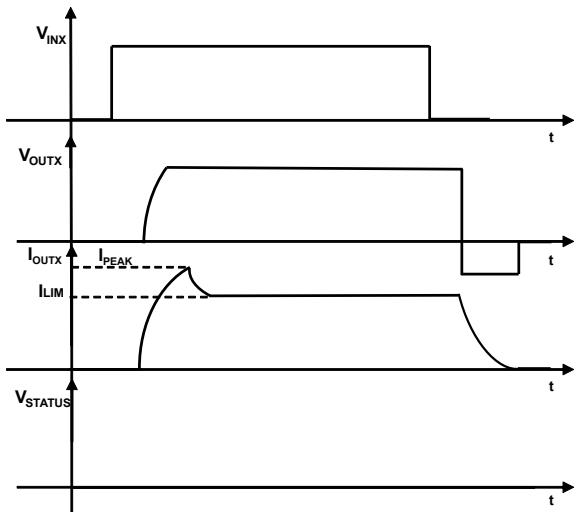
**Figure 7. Switching on bulb lamp load**

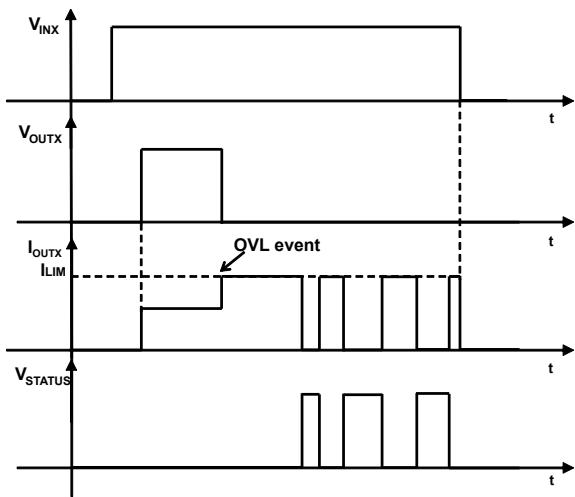
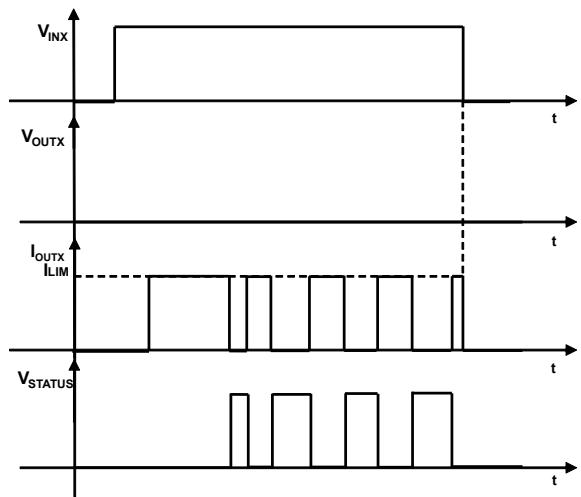


**Figure 8. Switching on light inductive load**



**Figure 9. Switching on heavy inductive load**



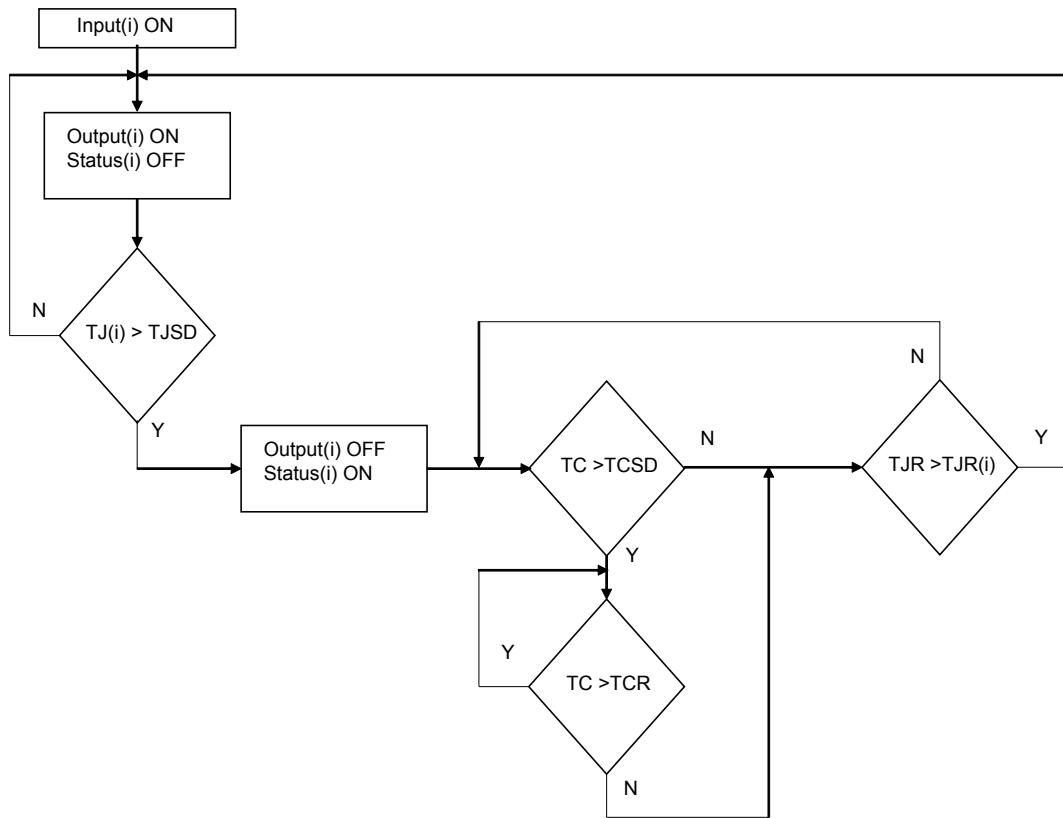
**Figure 10. Short-circuit during ON state**

**Figure 11. Switching on short-circuit**


## 7.2 Thermal protection

The device is protected against overheating due to overload conditions. When the output is overloaded during the driving period, the device suffers two different thermal stresses: the first relates to the junction, and the second relates to the case.

The two faults have different trigger thresholds: the junction protection threshold ( $T_{JSD}$ ) is higher than the case protection one ( $T_{CSD}$ ); generally the first protection that is activated in thermal stress conditions is the junction thermal shut-down. The output is turned-off when the temperature is higher than its threshold and turned back on when it falls below the reset threshold ( $T_{JR}$ ). This behavior continues while the fault on the output is present.

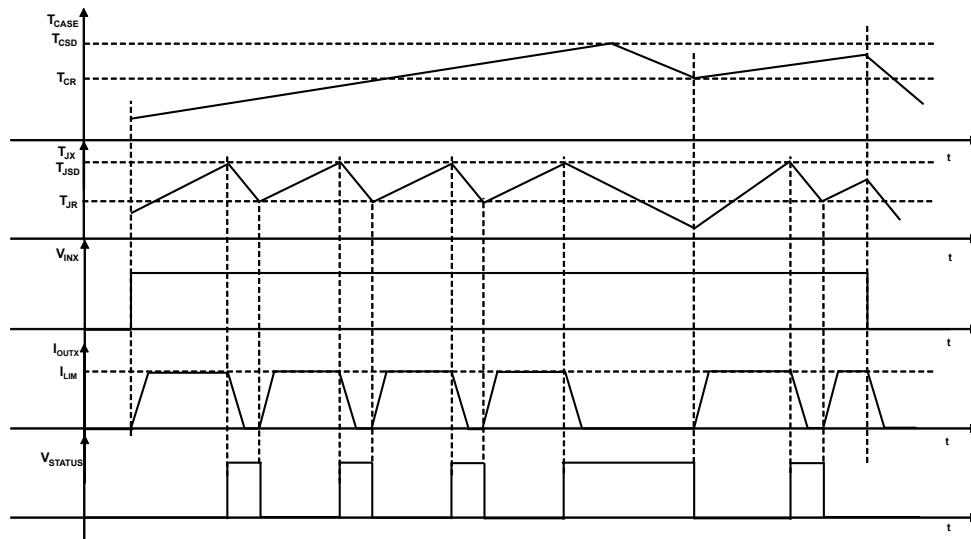
If the thermal protection is active and the temperature of the package increases above the fixed case protection threshold, the case protection is activated and the output is switched-off and back on when the junction temperature of each channel in fault and case temperature are below the respective reset thresholds.

**Figure 12. Thermal protection logic**


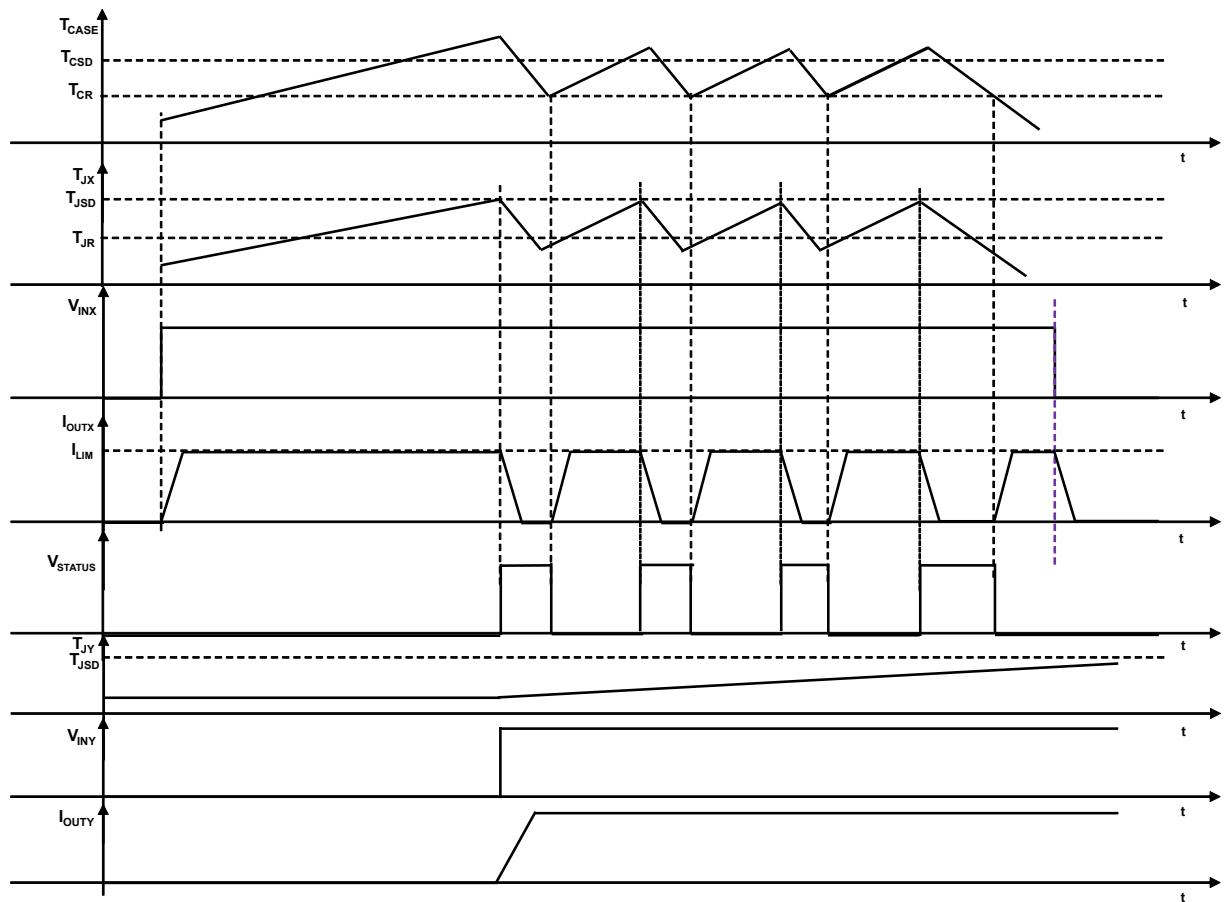
### 7.3 STATUS indication

The STATUS pin is an active high common open source output indicating fault conditions. This pin is activated in case of junction overtemperature ( $T_{JX} > T_{JSD}$ ) of one or more output channels. Figure 13 and Figure 14 show the STATUS behavior when  $T_{JSD}$  is triggered before  $T_{CSD}$  and when  $T_{CSD}$  is triggered before  $T_{JSD}$ , respectively.

**Figure 13. Thermal protection and STATUS behavior ( $T_{JSD}$  triggered before  $T_{CSD}$ )**



**Figure 14. Thermal protection and STATUS behavior ( $T_{CSD}$  triggered before  $T_{JSD}$ )**



## 8 Reverse polarity protection

Reverse polarity protection can be implemented on board using two different solutions:

1. Placing a resistor ( $R_{GND}$ ) between IC GND pin and load GND
2. Placing a diode between IC GND pin and load GND

If option 1 is selected, the minimum resistance value has to be selected according to the following equation:

$$R_{GND} \geq \frac{V_{CC}}{I_{GND}} \quad (1)$$

where  $I_{GND}$  is the DC reverse ground pin current and can be found in Maximum ratings.

Power dissipated by  $R_{GND}$  (when  $V_{CC} < 0$ : during reverse polarity situations) is:

$$P_D = \frac{(V_{CC})^2}{R_{GND}} \quad (2)$$

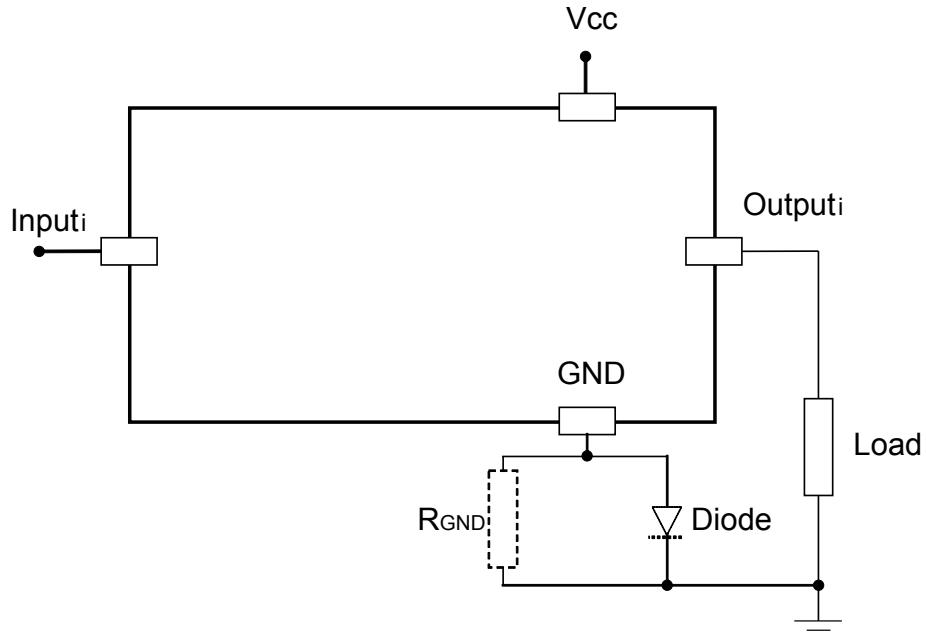
If option 2 is selected, the diode has to be chosen by taking into account  $V_{RRM} > |V_{CC}|$  and its power dissipation capability:

$$P_D \geq I_S \times V_f \quad (3)$$

Note:

*In normal operation (no reverse polarity), there is a voltage drop ( $\Delta V$ ) between GND of the device and GND of the system. Using option 1,  $\Delta V = R_{GND} * I_{CC}$ . Using option 2,  $\Delta V = V_F@IF$ .*

**Figure 15. Reverse polarity protection**

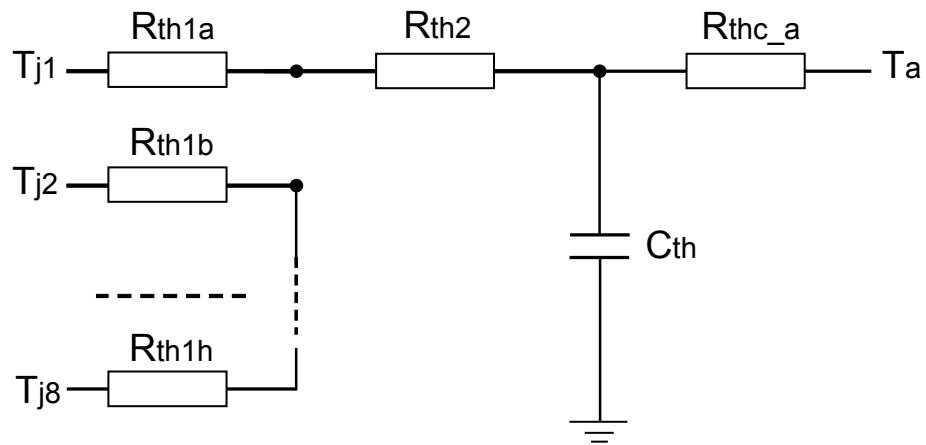


This schematic can be used with any type of load.

## 9 Thermal information

### 9.1 Thermal impedance

Figure 16. Simplified thermal model of the process stage

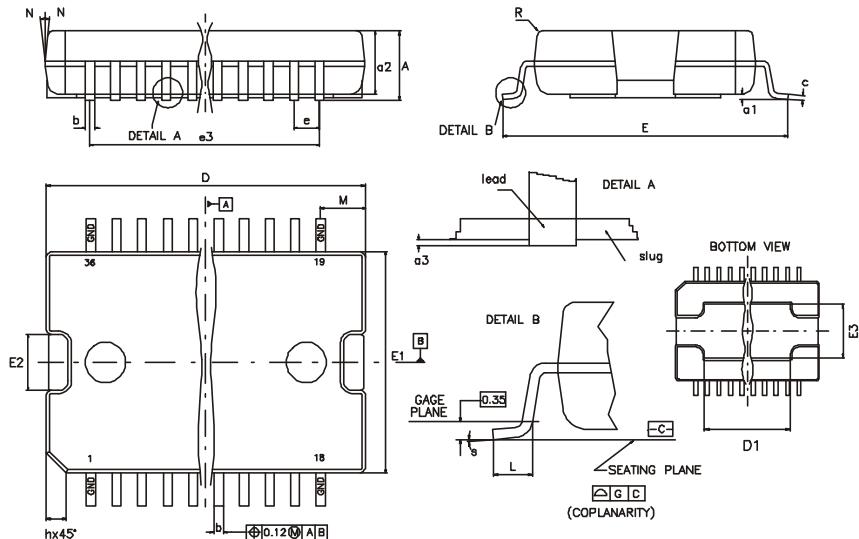


## 10 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK is an ST trademark.

### 10.1 PowerSO-36 package information

**Figure 17.** PowerSO-36 package outline



**Table 10.** PowerSO-36 package mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A			3.60
a1	0.10		0.30
a2			3.30
a3	0		0.10
b	0.22		0.38
c	0.23		0.32
D <sup>(1)</sup>	15.80		16.00
D1	9.40		9.80
E	13.90		14.50
E1 <sup>(1)</sup>	10.90		11.10
E2			2.90
E3	5.8		6.2
e		0.65	
e3		11.05	
G	0		0.10

Dim.	mm		
	Min.	Typ.	Max.
H	15.50		15.90
h			1.10
L	0.80		1.10
N			10°
S	0°		8°

1. D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.15 mm (0.006"). Critical dimensions are "a3", "E" and "G".

## 10.2 Footprint recommended data

Figure 18. Footprint recommended data

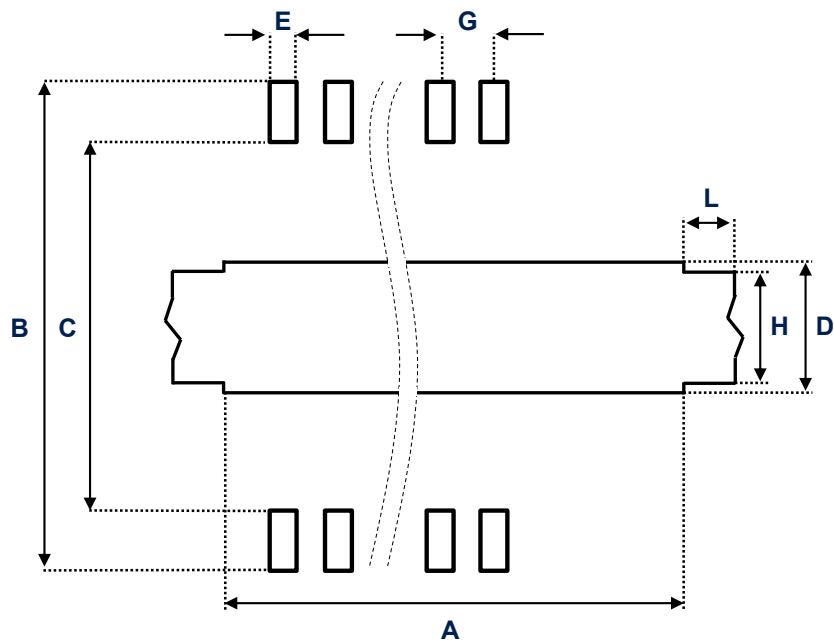


Table 11. Footprint data

Dim	mm
A	9.5
B	14.7 - 15.0
C	12.5 - 12.7
D	6.3
E	0.42
G	0.65
H	4.1
L	3.2

## 10.3 Tube shipment information

Figure 19. Tube shipment information

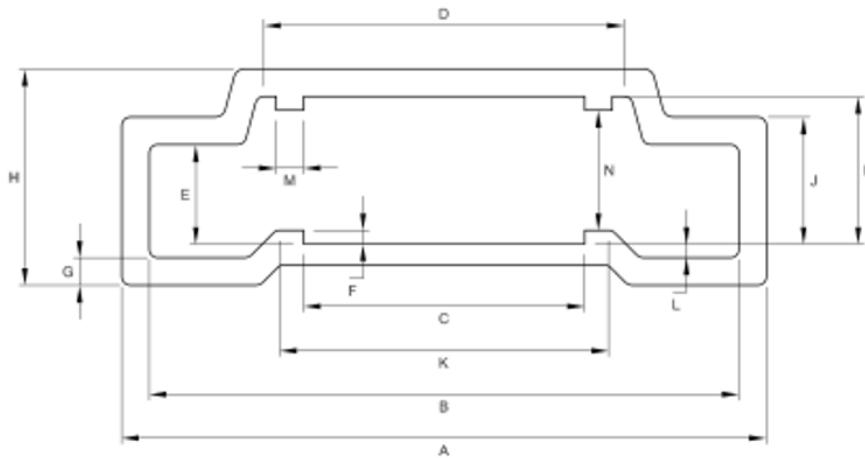


Table 12. Tube mechanical data

Dim	mm
A	18.80
B	17.2±0.2
C	8.20±0.2
D	10.90±0.2
E	2.90±0.2
F	0.40
G	0.80
H	6.30
I	4.30±0.2
J	3.7±0.2
K	9.4
L	0.40
M	0.80
N	3.50±0.2

## 10.4 Tape and reel shipment information

Figure 20. Tape specifications

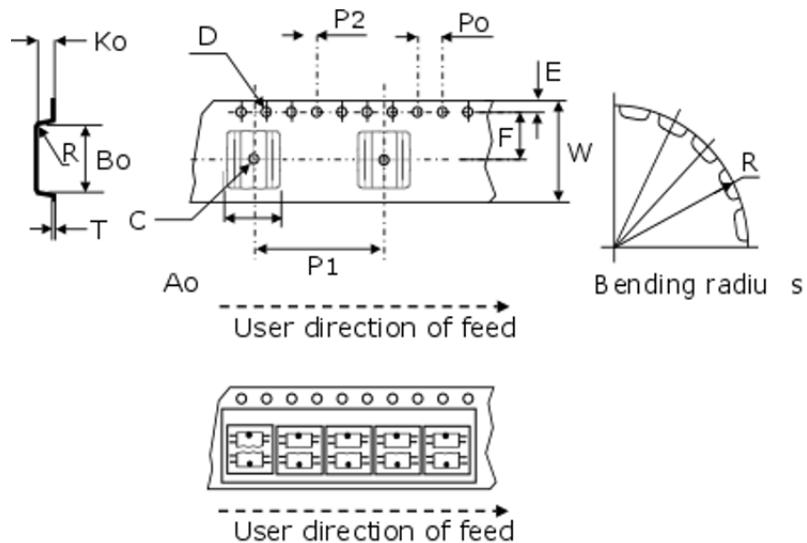


Table 13. Tape mechanical data

Dim	mm
D	1.50+0.1/0
E	1.75 ±0.1
P <sub>O</sub>	4.00 ±0.1
T <sub>max</sub>	0.40
D <sub>1min</sub>	1.50
F	11.5 ±0.05
K <sub>max</sub>	6.50
P <sub>2</sub>	2.00 ±0.1
R	50
W	24.00 ±0.30
P <sub>1</sub>	24.00
A <sub>O</sub> , B <sub>O</sub> , K <sub>O</sub>	0.05 min to 1.0 max

Figure 21. Reel specifications

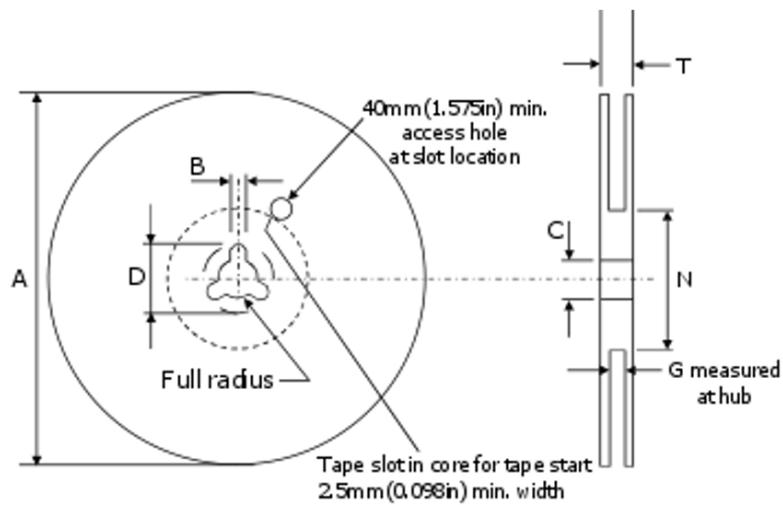


Table 14. Reel mechanical data

Dim	mm
Tape size	24.0±0.30
Amax	330.0
Bmin	1.5
C	13.0±0.20
Dmin	20.2
Nmin	60
G	24.4+2/-0
Tmax	30.4

## 11 Ordering information

**Table 15. Order code**

Order code	Package	Packaging
VN808CM-E	PowerSO-36	Tube
VN808CMTR-E		Tape and reel
VN808CM-32-E		Tube
VN808CMTR-32-E		Tape and reel

## Revision history

**Table 16. Document revision history**

Date	Version	Changes
29-Jun-2005	1	Initial release
12-Sep-2005	2	New template
28-Jun-2006	3	Application schematic updated
09-Jul-2008	4	Added Section 6: Reverse polarity protection
04-Aug-2008	5	Added Figure 9: PowerSO-36 drawings
26-Aug-2009	6	Updated Section 6: Reverse polarity protection
15-Sep-2009	7	Typing mistake in cover page: Section : Features and Table 5: Input pin
24-Feb-2010	8	Updated Section 7: Package mechanical data
01-Aug-2013	9	Updated Section 7.1: Footprint recommended data
18-Dec-2013	10	Replaced $L_{MAX}$ parameter in Table 1 by EAS parameter. Added $T_J$ condition to Table 3. Updated Section 6.
22-Jun-2020	11	Throughout document: - Added VN808CM-32-E technical and ordering information - Updated document template - Minor text changes In Section 3 : - Updated $I_{LGND}$ and $t_{d(VCCON)}$ test conditions In Table 4: - Updated all figure references In Table 6: - Added row $I_{PEAK}$ - Updated $I_{lim}$ test conditions In Table 9: - Updated figure reference for overtemperature In Section 6 : - Deleted Figure 6. Waveforms Added Section 7 Power section In Section 8 Reverse polarity protection: - Updated note "In normal..." - Updated Figure 15 Added Section 9
22-Feb-2021	12	Corrected AMR of $V_{IN}$ to 5.5 V in Table 1 ; deleted $V_{CC}$ operating range in Table 3.

## Contents

<b>1</b>	<b>Overview</b>	<b>2</b>
<b>2</b>	<b>Maximum ratings</b>	<b>3</b>
<b>3</b>	<b>Electrical characteristics</b>	<b>4</b>
<b>4</b>	<b>Pin connections</b>	<b>6</b>
<b>5</b>	<b>Current and voltage conventions and truth table</b>	<b>8</b>
<b>6</b>	<b>Switching time waveforms</b>	<b>9</b>
<b>7</b>	<b>Power section</b>	<b>10</b>
<b>7.1</b>	Current limitation	10
<b>7.2</b>	Thermal protection	11
<b>7.3</b>	STATUS indication	12
<b>8</b>	<b>Reverse polarity protection</b>	<b>14</b>
<b>9</b>	<b>Thermal information</b>	<b>15</b>
<b>9.1</b>	Thermal impedance	15
<b>10</b>	<b>Package information</b>	<b>16</b>
<b>10.1</b>	PowerSO-36 package information	16
<b>10.2</b>	Footprint recommended data	17
<b>10.3</b>	Tube shipment information	18
<b>10.4</b>	Tape and reel shipment information	19
<b>11</b>	<b>Ordering information</b>	<b>21</b>
	<b>Revision history</b>	<b>22</b>

## List of figures

<b>Figure 1.</b>	Internal schematic . . . . .	2
<b>Figure 2.</b>	Connection diagram (top view) . . . . .	6
<b>Figure 3.</b>	Current and voltage conventions . . . . .	8
<b>Figure 4.</b>	Turn-ON and turn-OFF . . . . .	9
<b>Figure 5.</b>	V <sub>CC</sub> turn-ON . . . . .	9
<b>Figure 6.</b>	Switching on resistive load . . . . .	10
<b>Figure 7.</b>	Switching on bulb lamp load . . . . .	10
<b>Figure 8.</b>	Switching on light inductive load . . . . .	10
<b>Figure 9.</b>	Switching on heavy inductive load . . . . .	10
<b>Figure 10.</b>	Short-circuit during ON state . . . . .	11
<b>Figure 11.</b>	Switching on short-circuit . . . . .	11
<b>Figure 12.</b>	Thermal protection logic . . . . .	12
<b>Figure 13.</b>	Thermal protection and STATUS behavior ( $T_{JSD}$ triggered before $T_{CSD}$ ) . . . . .	13
<b>Figure 14.</b>	Thermal protection and STATUS behavior ( $T_{CSD}$ triggered before $T_{JSD}$ ) . . . . .	13
<b>Figure 15.</b>	Reverse polarity protection . . . . .	14
<b>Figure 16.</b>	Simplified thermal model of the process stage . . . . .	15
<b>Figure 17.</b>	PowerSO-36 package outline . . . . .	16
<b>Figure 18.</b>	Footprint recommended data . . . . .	17
<b>Figure 19.</b>	Tube shipment information . . . . .	18
<b>Figure 20.</b>	Tape specifications . . . . .	19
<b>Figure 21.</b>	Reel specifications . . . . .	20

## List of tables

<b>Table 1.</b>	Absolute maximum ratings . . . . .	3
<b>Table 2.</b>	Thermal data . . . . .	3
<b>Table 3.</b>	Power section . . . . .	4
<b>Table 4.</b>	Switching ( $V_{CC} = 24\text{ V}$ ) . . . . .	4
<b>Table 5.</b>	Input pins . . . . .	4
<b>Table 6.</b>	Protections . . . . .	5
<b>Table 7.</b>	Status pin . . . . .	5
<b>Table 8.</b>	Pin functions . . . . .	6
<b>Table 9.</b>	Truth table . . . . .	8
<b>Table 10.</b>	PowerSO-36 package mechanical data . . . . .	16
<b>Table 11.</b>	Footprint data . . . . .	17
<b>Table 12.</b>	Tube mechanical data . . . . .	18
<b>Table 13.</b>	Tape mechanical data . . . . .	19
<b>Table 14.</b>	Reel mechanical data . . . . .	20
<b>Table 15.</b>	Order code . . . . .	21
<b>Table 16.</b>	Document revision history . . . . .	22

**IMPORTANT NOTICE – PLEASE READ CAREFULLY**

STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice. Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST's terms and conditions of sale in place at the time of order acknowledgement.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of Purchasers' products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and the ST logo are trademarks of ST. For additional information about ST trademarks, please refer to [www.st.com/trademarks](http://www.st.com/trademarks). All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.

© 2021 STMicroelectronics – All rights reserved

# X-ON Electronics

Largest Supplier of Electrical and Electronic Components

*Click to view similar products for Gate Drivers category:*

*Click to view products by STMicroelectronics manufacturer:*

Other Similar products are found below :

[00053P0231](#) [56956](#) [57.404.7355.5](#) [LT4936](#) [57.904.0755.0](#) [5882900001](#) [00600P0005](#) [00-9050-LRPP](#) [00-9090-RDPP](#) [5951900000](#) [01-1003W-10/32-15](#) [0131700000](#) [00-2240](#) [LTP70N06](#) [LVP640](#) [5J0-1000LG-SIL](#) [LY1D-2-5S-AC120](#) [LY2-US-AC240](#) [LY3-UA-DC24](#)  
[00576P0020](#) [00600P0010](#) [LZN4-UA-DC12](#) [LZNQ2M-US-DC5](#) [LZNQ2-US-DC12](#) [LZP40N10](#) [00-8196-RDPP](#) [00-8274-RDPP](#) [00-8275-RDNP](#) [00-8722-RDPP](#) [00-8728-WHPP](#) [00-8869-RDPP](#) [00-9051-RDPP](#) [00-9091-LRPP](#) [00-9291-RDPP](#) [0207100000](#) [0207400000](#) [60100564](#)  
[01312](#) [0134220000](#) [60713816](#) [M15730061](#) [61161-90](#) [61278-0020](#) [6131-204-23149P](#) [6131-205-17149P](#) [6131-209-15149P](#) [6131-218-17149P](#)  
[6131-220-21149P](#) [6131-260-2358P](#) [6131-265-11149P](#)